

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
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Application Number:	13484480																
CORRESPONDENCE DATA																	
Fax Number:	2156894905																
Phone:	215-979-1000																
Email:	jsjiulianti@duanemorris.com																
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>																	
Correspondent Name:	DUANE MORRIS LLP (TSMC) IP DEPARTMENT																
Address Line 1:	30 SOUTH 17TH STREET																
Address Line 4:	PHILADELPHIA, PENNSYLVANIA 19103-4196																

ATTORNEY DOCKET NUMBER:	2011.1480/1085.01013
NAME OF SUBMITTER:	Steven E. Koffs
Total Attachments: 4 source=executedAssign#page1.tif source=executedAssign#page2.tif source=executedAssign#page3.tif source=executedAssign#page4.tif	

ATTORNEY DOCKET NO.: 2011.1480/1085.01013

ASSIGNMENT AND AGREEMENT

For value received, we, **Mu-Jen HUANG, Yu-Sian JIANG, Yi-Ting LIN, Hsien-Yu TSENG, Heng Kai LIU, Chien-Wen CHEN and Chauchin SU**, hereby transfer to **Taiwan Semiconductor Manufacturing Co., Ltd.**, with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **METHOD AND SYSTEM FOR LAYOUT PARASITIC ESTIMATION**, described in a non-provisional application, and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: ✓ 6/1 2012

✓ Mu-Jen Huang
Mu-Jen HUANG

Residence:

4F., No. 25-2, Lane 76, Section 2, Heping E. Road, Da-an District, Taipei City 106, Taiwan, R.O.C.

Inventor No. 2

Dated: ✓ 2012.6.1

✓ Yu-Sian Jiang
Yu-Sian JIANG

Residence:

No. 18, Minfu Street, Gushan District, Kaohsiung City 804, Taiwan, R.O.C.

Inventor No. 3

Dated: ✓ 2012.6.1

✓ Yi-Ting Lin
Yi-Ting LIN

Residence:

No. 8, Alley 19, Lane 110, Gaofeng Road, East District, Hsinchu City 300, Taiwan, R.O.C.

Inventor No. 4

Dated: ✓ 2011.6.11

✓ Hsien Yu-TSENG
Hsien-Yu TSENG

Residence:

No. 48, Ren-ai Road, Tongxiao Township, Miaoli County 357, Taiwan, R.O.C.

Inventor No. 5

Dated: ✓ 2011.6.1

✓ Heng Kai LIU
Heng Kai LIU

Residence:

No. 16, Alley 50, Lane 430, Section 2, Yanping Road, Pingzhen City, Taoyuan County 324, Taiwan, R.O.C.

Inventor No. 6

Dated: ✓ 2012.6.6

✓ Chien-Wen CHEN
Chien-Wen CHEN

Residence:

8F.-1, No. 32, Tiyu Street, Hsinchu City 300, Taiwan, R.O.C.

ATTORNEY DOCKET NO.: 2011.1480/1085.01013

Inventor No. 7

Dated: ✓ 2012 6/4

✓ 
Chauchin SU

Residence:

No. 5-12, Alley 78, Lane 59, Hami Street, Datong District, Taipei City 103, Taiwan,
R.O.C.